



IFW

XA-10076  
PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Kan YASUI et al.

Appln. No.: 10/814,627

Group Art Unit: 2812

Filed: April 1, 2004

For: MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE

\* \* \*

INFORMATION DISCLOSURE STATEMENT

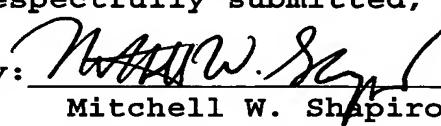
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.56, and without any assertion as to materiality or prior art effect, the documents listed on the attached Form PTO-1449 are hereby cited.

The documents listed on the attached List are cited in the specification, on pages 3, 6, 9, and 17, and their relevance is indicated therein. Copies of the listed foreign patent documents are attached.

Respectfully submitted,

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MWS:jab

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July 22, 2004

FORM PTO-1449			Atty. Docket No.	Appln. No.
LIST OF DOCUMENTS CITED BY APPLICANT			XA-10076	10/814,627
O I P E JUL 22 2004 TRADEMAKES			Applicant	
			Kan YASUI	
			Filing Date	Group
			April 1, 2004	2812

## U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-class	Filing Date
	AA	6,551,925	4/22/03	Iguchi et al.	438	637	
	AB	6,596,607	7/22/03	Ahn	438	424	
	AC	6,410,456	6/25/02	Gronet et al.	43	769	
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

## FOREIGN PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Country	Class	Sub-class	Translation
	AL	2002-43408	2/8/02	Japan (corresponds to U.S. 6,551,925)			Abstract
	AM	2002-203895	7/19/02	Japan (corresponds to U.S. 6,596,607)			Abstract
	AN						
	AO						
	AP						
	AQ						
	AR						
	AS						

## OTHER (including author, title, date, pertinent pages, etc.)

Examiner	AT	
		Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.